

FILTERLESS 3W CLASS-D STEREO AUDIO AMPLIFIER

Description

The PAM8004 is a 3Wm Class-D audio amplifier. It offers low THD+N, allowing it to achieve high quality sound reproduction. The new filterless architecture allows the device to drive the speaker directly, requiring no low-pass output filters, in order to save system cost and PCB area.

With the same numbers of external components, the efficiency of the PAM8004 is much better than that of Class-AB cousins. It can extend the battery life, ideal for portable applications

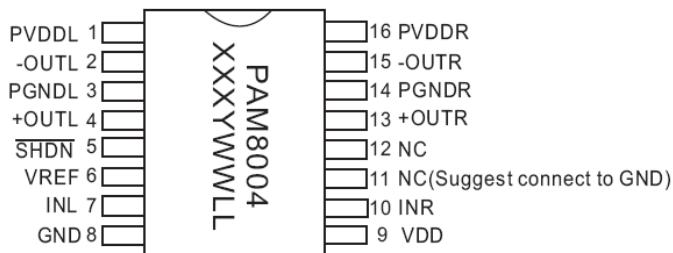
The PAM8004 is available in SOP-16L package.

Features

- 3W Output at 10% THD with a 3Ω Load and
- 5V Power Supply
- 2.5W Output at 10% THD with a 4Ω Load and 5V Power Supply
- Filterless, Low Quiescent Current and Low EMI
- Low THD+N
- Superior Low Noise
- Short Circuit Protection
- Thermal Shutdown
- Few External Components to Save the Space and Cost
- Pb-Free Package

Pin Assignments

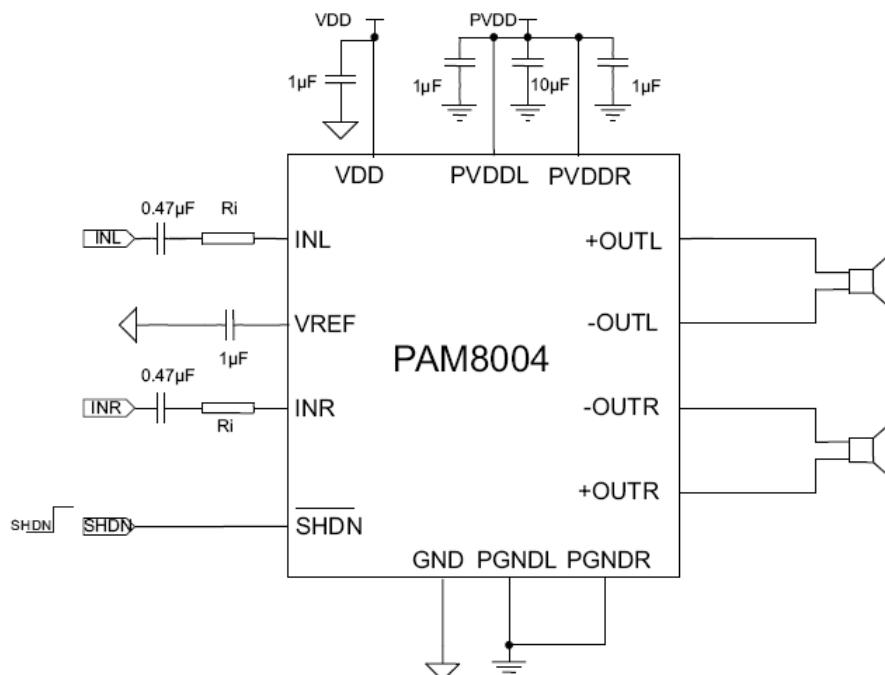
Top View
SOP-16



Applications

- Portable Speakers
- LCD Monitors / TV
- Notebook Computers
- Portable DVD Players, Game Machines

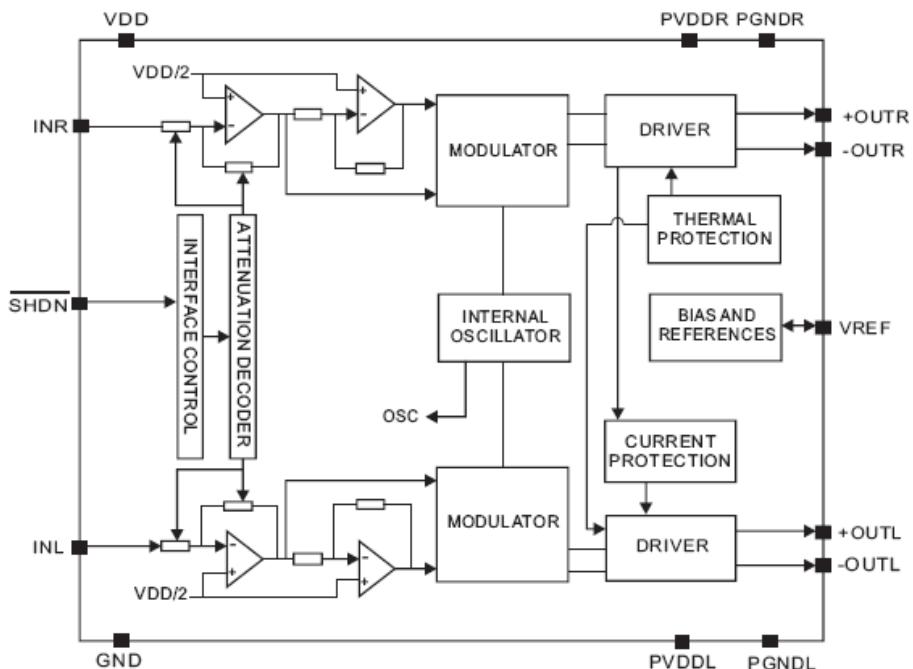
Typical Applications Circuit



Pin Descriptions

Pin Number	Pin Name	Function
1	PVDDL	Left Channel Power Supply
2	-OUTL	Left Channel Negative Output
3	PGNDL	Left Channel Power GND
4	+OUTL	Left Channel Positive Output
5	SHDN	Shutdown Control Input (active low)
6	VREF	Internal Analog Reference, Connect a Bypass Capacitor from VREF to GND
7	INL	Left Channel Input
8	GND	Analog Ground
9	VDD	Analog Power Supply
10	INR	Right Channel Input
11	NC	Not Connected (Suggest Connect to GND)
12	NC	Not Connected
13	+OUTR	Right Channel Positive Output
14	PGNDR	Right Channel Power GND
15	-OUTR	Right Channel Negative Output
16	PVDDR	Right Channel Power Supply

Functional Block Diagram



Absolute Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Supply Voltage	6.0	V
Input Voltage	-0.3 to $V_{DD} + 0.3$	
Maximum Junction Temperature	150	°C
Storage Temperature	-65 to 150	
Soldering Temperature	300, 5sec	

Recommended Operating Conditions (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage Range	2.5 to 5.5	V
Operation Temperature Range	-40 to +85	°C
Junction Temperature Range	-40 to +125	°C

Thermal Information

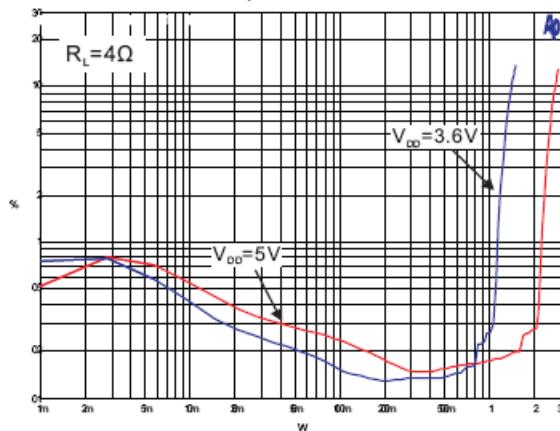
Parameter	Package	Symbol	Max	Unit
Thermal Resistance (Junction to Ambient)	SOP-16L	θ_{JA}	110	°C/W
Thermal Resistance (Junction to Case)	SOP-16L	θ_{JC}	23	
Internal Power Dissipation @ $T_A = +25^\circ\text{C}$	SOP-16L	P_D	900	mW

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, $V_{DD} = 5\text{V}$, Gain = 24dB, $R_L = 8\Omega$, unless otherwise specified.)

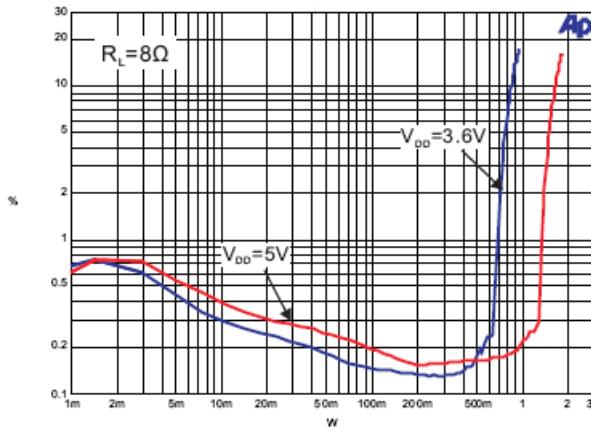
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
V_{IN}	Supply Power		2.5		5.5	V
P_o	Output Power	THD+N = 10%, $f = 1\text{kHz}$, $R_L = 4\Omega$	$V_{DD} = 5.0\text{V}$	2.5		W
		THD+N = 1%, $f = 1\text{kHz}$, $R_L = 4\Omega$	$V_{DD} = 5.0\text{V}$	2.2		W
		THD+N = 10%, $f = 1\text{kHz}$, $R_L = 8\Omega$	$V_{DD} = 5.0\text{V}$	1.65		W
		THD+N = 1%, $f = 1\text{kHz}$, $R_L = 8\Omega$	$V_{DD} = 5.0\text{V}$	1.3		W
THD+N	Total Harmonic Distortion Plus Noise	$V_{DD} = 5.0\text{V}$, $P_o = 0.5\text{W}$, $R_L = 8\Omega$	$f = 1\text{kHz}$	0.16		%
		$V_{DD} = 3.6\text{V}$, $P_o = 0.5\text{W}$, $R_L = 8\Omega$		0.12		%
		$V_{DD} = 5.0\text{V}$, $P_o = 1\text{W}$, $R_L = 4\Omega$	$f = 1\text{kHz}$	0.17		%
		$V_{DD} = 3.6\text{V}$, $P_o = 1\text{W}$, $R_L = 4\Omega$		0.26		%
PSRR	Power Supply Ripple Rejection	$V_{DD} = 5.0\text{V}$, Inputs AC-Grounded with $C_{IN} = 0.47\mu\text{F}$, $G_v = 6\text{dB}$	$f = 1\text{kHz}$		-70	dB
C_s	Crosstalk	$V_{DD} = 5\text{V}$, $P_o = 0.5\text{W}$, $R_L = 8\Omega$, $G_v = 20\text{dB}$	$f = 1\text{kHz}$		-93	dB
SNR	Signal-to-Noise	$V_{DD} = 5\text{V}$, $G_v = 6\text{dB}$	$f = 1\text{kHz}$		86	dB
V_N	Output Noise	$V_{DD} = 5\text{V}$, Inputs AC-Grounded with $C_{IN} = 0.47\mu\text{F}$, $G_v = 6\text{dB}$	A-weighting		33	μV
			No A-weighting		50	
η	Efficiency	$R_L = 8\Omega$, THD = 10%	$f = 1\text{kHz}$		87	%
		$R_L = 4\Omega$, THD = 10%			79	
I_Q	Quiescent Current	$V_{DD} = 5.0\text{V}$	No load		4.5	7.0
		$V_{DD} = 3.6\text{V}$			4.0	6.5
		$V_{DD} = 3.0\text{V}$			3.7	5.5
I_{SD}	Shutdown Current	$V_{DD} = 2.5\text{V}$ to 5.5V			1	μA
$R_{DS(ON)}$	Static Drain-to-Source On-State Resistor	$I_{DS} = 500\text{mA}$, $V_{GS} = 5\text{V}$	PMOS		0.41	$\text{m}\Omega$
			NMOS		0.27	
f_{sw}	Switching Frequency	$V_{DD} = 3\text{V}$ to 5V			210	kHz
V_{OS}	Output Offset Voltage	$V_{IN} = 0\text{V}$, $V_{DD} = 5\text{V}$			10	mV
V_{IH}	Enable Input High Voltage	$V_{DD} = 5.0\text{V}$		1.5		V
V_{IL}	Enable Input Low Voltage	$V_{DD} = 5.0\text{V}$			0.4	
OTP	Over Temperature Protection	No Load, Junction Temperature	$V_{DD} = 5\text{V}$		150	$^\circ\text{C}$
OTH	Over Temperature Hysteresis				30	

Typical Performance Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

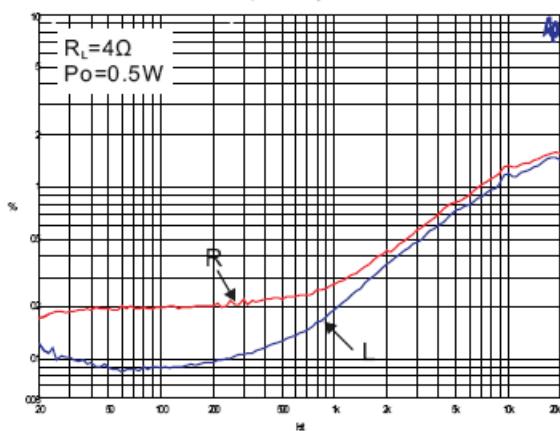
1. THD+N vs Output Power



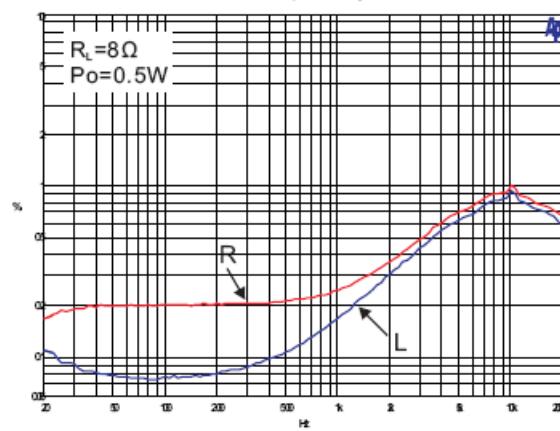
2. THD+N vs Output Power



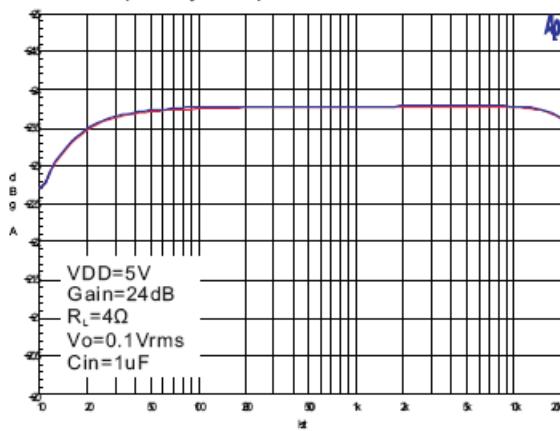
3. THD+N vs Frequency



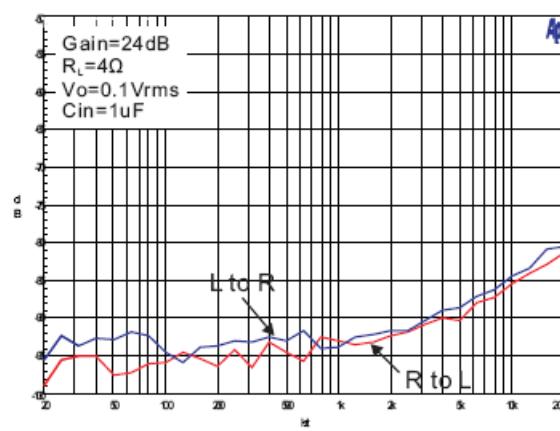
4. THD+N vs Frequency



5. Frequency Response

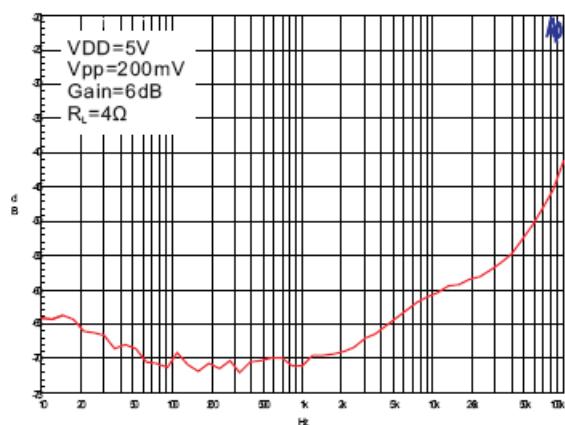


6. Crosstalk

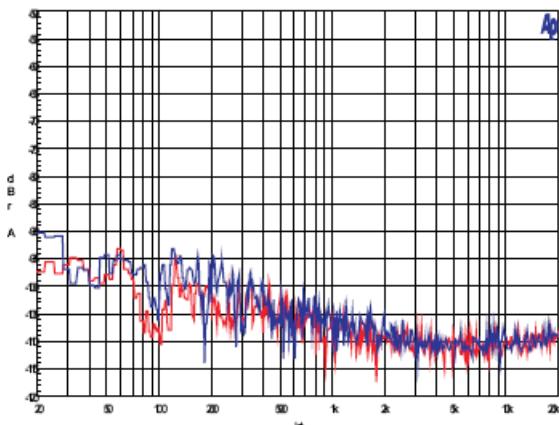


Typical Performance Characteristics (cont.) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

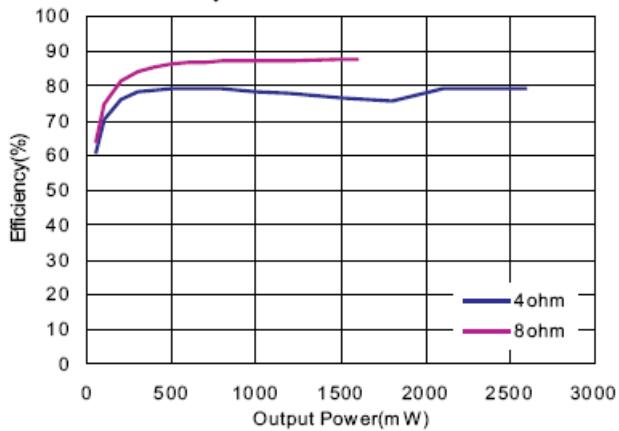
7. PSRR



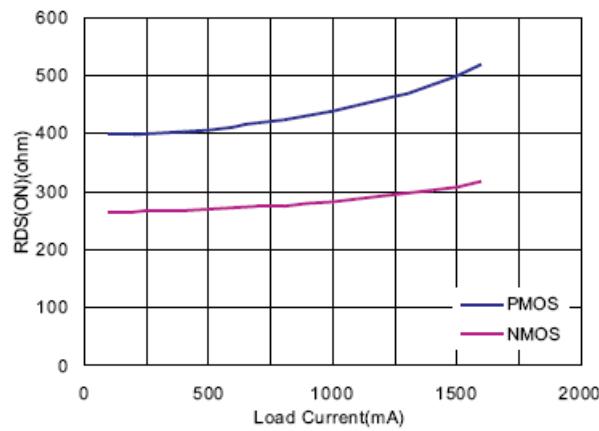
8. FFT noise



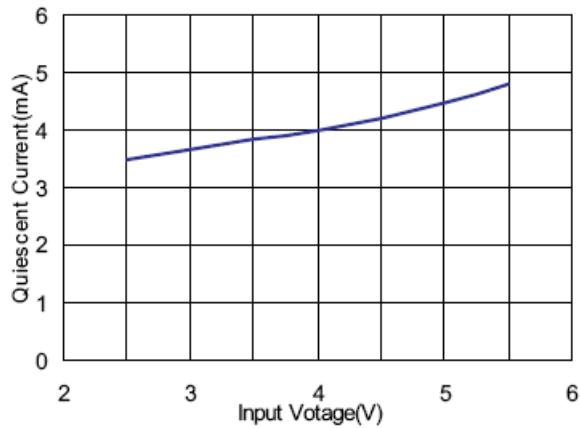
9. Efficiency



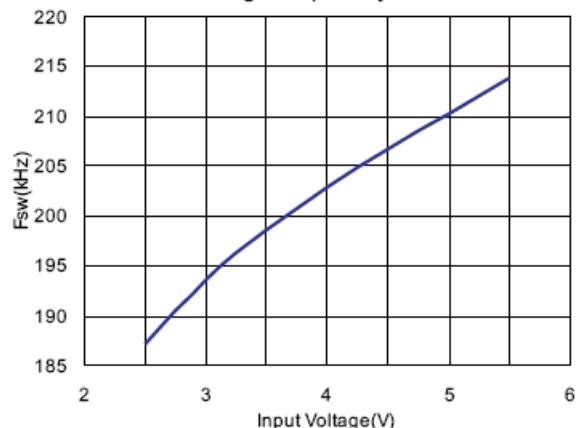
10. Rdson VS Load Current



11. Quiescent Current



12. Switching Frequency



Application Information

Maximum Gain

As shown in block diagram (Page 2), the PAM8403 has two internal amplifier stages. The first stage's gain is externally configurable, while the second stage's is internally fixed. The closed-loop gain of the first stage is set by selecting the ratio of R_F to R_I while the second stage's gain is fixed at 2x. The output of amplifier 1 serves as the input to amplifier 2, thus the two amplifiers produce signals identical in magnitude, but different in phase by 180°.

Consequently, the differential gain for the IC is

$$A_{VD} = 20 * \log[2 * (R_F / R_I)]$$

The PAM8403 sets maximum $R_F = 142\text{k}\Omega$, minimum $R_I = 18\text{k}\Omega$, so the maximum closed-gain is 24dB.

Power Supply Decoupling

The PAM8004 is a high performance CMOS audio amplifier that requires adequate power supply decoupling to ensure the output THD and PSRR as low as possible. Power supply decoupling affects low frequency response. Optimum decoupling is achieved by using two capacitors of different types of noise on the power supply leads. For higher frequency transients, spikes, or digital hash on the line, a good low equivalent-series-resistance (ESR) ceramic capacitor, typically 1.0μF, works best, placing it as close as possible to the device VDD terminal. For filtering lower-frequency noise signals, a large capacitor of 20μF (ceramic) or greater is recommended, placing it near the audio power amplifier.

Input Capacitor (C_I)

Large input capacitors are both expensive and space hungry for portable designs. Clearly, a certain sized capacitor is needed to couple in low frequencies without severe attenuation. But in many cases the speakers used in portable systems, whether internal or external, have little ability to reproduce signals below 100Hz to 150Hz. Thus, using a large input capacitor may not increase actual system performance. In this case, input capacitor (C_I) and input resistance (R_I) of the amplifier form a high-pass filter with the corner frequency determined by equation below.

$$f_C = \frac{1}{2\pi R_I C_I}$$

In addition to system cost and size, click and pop performance is affected by the size of the input the coupling capacitor, C_I . A larger input coupling capacitor requires more charge to reach its quiescent DC voltage (nominally $\frac{1}{2} V_{DD}$). This charge comes from the internal circuit via the feedback and is apt to create pops upon device enable. Thus, by minimizing the capacitor size based on necessary low frequency response, turn-on pops can be minimized.

Analog Reference Bypass Capacitor (C_{BYP})

The Analog Reference Bypass Capacitor (C_{BYP}) is the most critical capacitor and serves several important functions. During start-up or recovery from shutdown mode, C_{BYP} determines the rate at which the amplifier starts up. The second function is to reduce noise caused by the power supply coupling into the output drive signal. This noise is from the internal analog reference to the amplifier, which appears as degraded PSRR and THD+N.

A ceramic bypass capacitor (C_{BYP}) with values of 0.1μF to 1.0μF is recommended for the best THD and noise performance. Increasing the bypass capacitor reduces clicking and popping noise from power on/off and entering and leaving shutdown.

Under-Voltage Lock-Out (UVLO)

The PAM8004 incorporates circuitry designed to detect low supply voltage. When the supply voltage drops to 2.0V or below, the PAM8004 outputs are disabled, and the device comes out of this state and starts to normal function when $V_{DD} \geq 2.2V$.

Short Circuit Protection (SCP)

The PAM8004 has short circuit protection circuitry on the outputs to prevent damage to the device when output-to-output or output-to-GND short occurs. When a short circuit is detected on the outputs, the outputs are disabled immediately. If the short was removed, the device activates again.

Over Temperature Protection

Thermal protection on the PAM8004 prevents the device from damage when the internal die temperature exceeds +140°C. There is a 15 degree tolerance on this trip point from device to device. Once the die temperature exceeds the thermal set point, the device outputs are disabled. This is not a latched fault. The thermal fault is cleared once the temperature of the die is reduced by +30°C. This large hysteresis will prevent motor boating sound well and the device begins normal operation at this point without external system intervention.

Application Information (cont.)

How to Reduce EMI (Electro Magnetic Interference)

A simple solution is to put an additional capacitor 1000 μ F at power supply terminal for power line coupling if the traces from amplifier to speakers are short (< 20cm).

Most applications require a ferrite bead filter as shown in Figure 2. The ferrite filter reduces EMI of around 1 MHz and higher. When selecting a ferrite bead, choose one with high impedance at high frequencies, and low impedance at low frequencies.

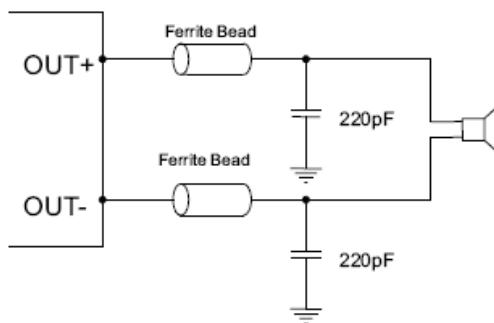
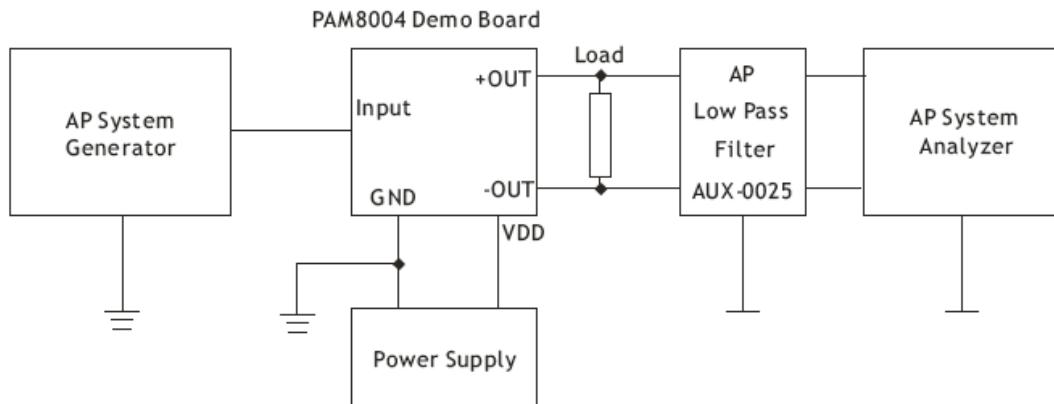


Figure 2. Ferrite Bead Filter to Reduce EMI

Application Notes

1. When the PAM8004 works with LC filters, it should be connected with the speaker before it's powered on, otherwise it will be damaged easily.
2. When the PAM8004 works without LC filters, it's better to add a ferrite chip bead at the outgoing line of speaker for suppressing the possible electromagnetic interference.
3. The recommended operating voltage is 5.5V. When the PAM8004 is powered with four battery cells, it should be noted that the voltage of four new dry or alkaline batteries is over 6.0V, higher than its operation voltage, which will probably damage the device. Therefore, it's recommended to use either four Ni-MH (Nickel Metal Hydride) rechargeable batteries or three dry or alkaline batteries.
4. One should not make the input signal too large. Large signal can cause the clipping of output signal when increasing the volume. This will damage the device because of big gain of the PAM8004.
5. When testing the PAM8004 without LC filters by using resistor instead of speakers as the output load, the test results, e.g. THD or efficiency, will be worse than those of using speaker as load.

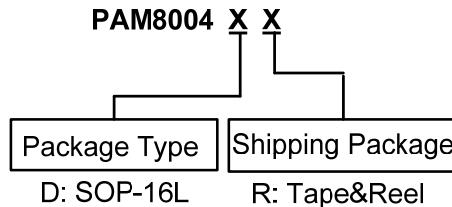
Test Setup for Performance Testing



Notes:

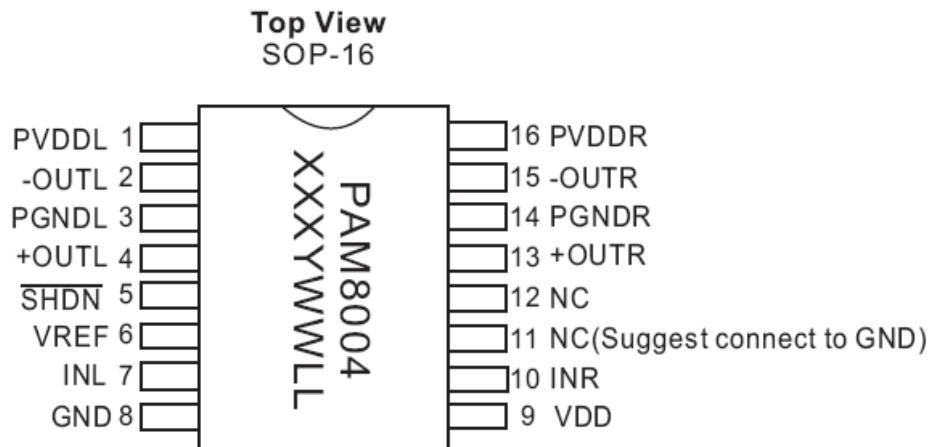
1. The AP AUX-0025 low pass filter is necessary for class-D amplifier measurement with AP analyzer.
2. Two 22 μ H inductors are used in series with load resistor to emulate the small speaker for efficiency measurement.

Ordering Information



Part Number	Part Marking	Package Type	Standard Package
PAM8004DR	PAM8004 XATYWWLL	SOP-16L	2500 Units/Tape&Reel

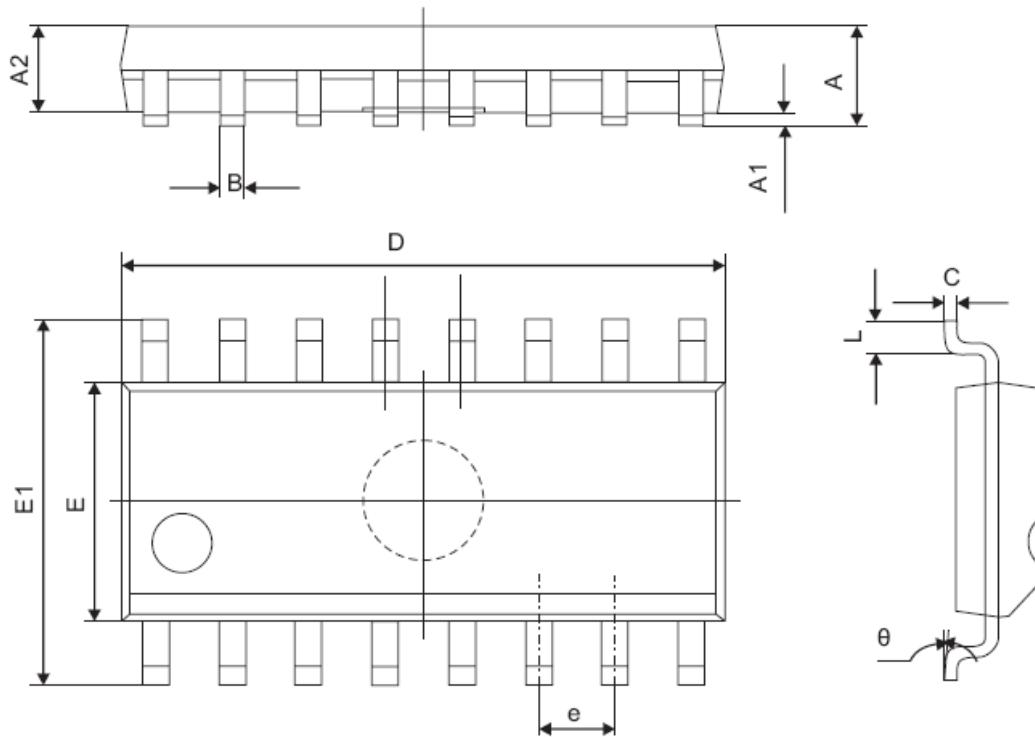
Marking Information



X: Internal Code
 Y: Year
 WW: Week
 LL: Internal Code

Package Outline Dimensions (All dimensions in mm.)

SOP-16



Symbol	Dimensions Millimeters	
	Min	Max
A	1.350	1.750
A1	0.100	0.250
A2	1.350	1.550
B	0.330	0.510
C	0.190	0.250
D	9.800	10.000
E	3.800	4.000
E1	5.800	6.300
e	1.270(TYP)	
L	0.400	1.270
θ	0°	8°

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